

XGS 5000, XGS 3000 and XGS 2000 Global Shutter CMOS Image Sensors

XGS Family

Description

The XGS CMOS image sensor family provides high performance global shutter image capture. The family comes in different resolutions in a single package: 2, 3 and 5 MP with up to 2/3-inch optical format. The 16 mm x 16 mm package makes the XGS family particularly suited for integration in 29 mm x 29 mm camera formats. The high speed, 12-bit output maximally leverages interfaces such as USB 3.2, Thunderbolt ™ 2 and 10 GigE.

Image data is read out through a column ADC architecture and then transferred over a HiSPi interface. On-chip logic, programmable via the serial interface, generates internal timing for integration and readout control. Up to three register configurations can be programmed and sequentially enabled (frame by frame) using a single command over the control interface.

Table 1. KEY PERFORMANCE PARAMETERS

Parameter	Typical Value				
Optical Format	XGS 5000	2/3-inch (10.6 mm Diagonal)			
	XGS 3000	1/2-inch (8.2 mm Diagonal)			
	XGS 2000	1/.2.2-inch (7.3 mm Diagonal)			
Active Pixels	XGS 5000	2592 (H) x 2048 (V)			
	XGS 3000	2048 (H) x 1536 (V)			
	XGS 2000	1920 (H) x 1200 (V)			
Pixel Size	3.2 μm				
Color Filter Array	Monochrome, Bayer				
Shutter Type	Global Shutter				
Input Clock	32.4 MHz				
Output Interface	HiSPi (16 Lanes - 777.6 Mbps/lane)				
Frame Rate (12-bit)	16 Lanes (-X4)				
	XGS 5000	132			
	XGS 3000	175			
	XGS 2000	220			
	4 Lanes (-X5)				
	XGS 5000	43			
Read Noise	4 e- (1x), 1.9 e- (4x)				
SNR _{MAX}	40 dB				
Dynamic Range	68 dB				
Supply Voltages	1.2 V, 2.8 V, 3 V (0.4 V, 1.8 V Optional)				
Power Consumption	0.75 W				
Operating Temp.	-40°C to 85°C (Junction)				
Package	163-pin iLGA (Inspectable Land Grid Array)				

ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

Non-NDA Data Sheet

Interested in what you see? If you would like more detailed information, please request the full version of our data sheet.

Request Full Data Sheet

Features

- On-chip 12-bit Column ADCs
- 10-bit Mode with Increased Frame Rate of 148 fps (16-lane) at Full Resolution
- Companding & 10-Bit Mode at 100 fps (8-lane) and 50 fps (8-lane)
- Dual Gain Mode with 74.5 dB Dynamic Range ($T_J = 40$ °C) at Half Frame Rate
- Data Interface: 16-lane HiSPi (Scalable Low-Voltage Signaling)
- Configurable Number of HiSPi Lanes: 16, 12, 8 or 4 Lanes
- Two-Wire (I2C) and Four-Wire (SPI)
 Serial Interface
- Triggered Integration and Readout Control
- Programmable Control for up to 8 Regions of Interest (ROI)
- · Context Switching
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

Applications

- Machine Vision
- Security
- Intelligent Transportation Systems (ITS)
- Broadcasting
- Medical
- Scientific

XGS Family

Table 2. ORDERABLE PART NUMBERS (Note 2)

Part Number		Product Description				Resolution (H x V)
NOIX4SN5000B-LTI	5 MP	Mono	Production device	0° CRA		
NOIX4SE5000B-LTI	5 MP	Color	Production device	0° CRA	16 Lanes	2592 x 2048
NOIX4SF5000B-LTI	5 MP	Color	Production device	4.7° CRA		
NOIX5SN5000B-LTI	5 MP	Mono	Production device	0° CRA	1	
NOIX5SE5000B-LTI	5 MP	Color	Production device	0° CRA	4 Lanes	
NOIX4SF3000B-LTI	3 MP	Color	Production device	4.7° CRA	40.1	2048 x 1536
NOIX4SP3000B-LTI	3 MP	Mono	Production device	4.7° CRA	16 Lanes	
	-					
NOIX4SN2000B-LTI	2 MP	Mono	Production device	0° CRA	401	1920 x 1200
NOIX4SE2000B-LTI	2 MP	Color	Production device	0° CRA	- 16 Lanes	

Production Device part numbers are listed for informational purpose only. Production Device part numbers are not available for orders at this time. Please contact **onsemi** for availability dates.

Table 3. ORDERING INFORMATION EVALUATION KITS

Part Number	Product Description	Additional Information
NOIX4SN5000KBLFB-GEVB	Sensor Headboard (5 MP, Mono, 16-Lane)	Demo Kit Headboard (incl. NOIX4SN5000KB-LTI) (Note 3)
NOIX4SE5000KBLFB-GEVB	Sensor Headboard (5 MP, Color, 16-Lane)	Demo Kit Headboard (incl. NOIX4SE5000KB-LTI) (Note 3)
AGBAN6CS-GEVK	Frame Buffer Demo Board	AP21088 including Power Adapter
AGB1N0CS-GEVK	Demo 3 Board	FPGA Base Board including USB Cable and Tripod

^{3.} Sensors are soldered to the headboard.

^{2.} See the **onsemi** Device Nomenclature document (TND310/D) for a full description of the naming convention used for image sensors. For reference documentation, including information on evaluation kits, please visit our web site at www.onsemi.com.

XGS Family

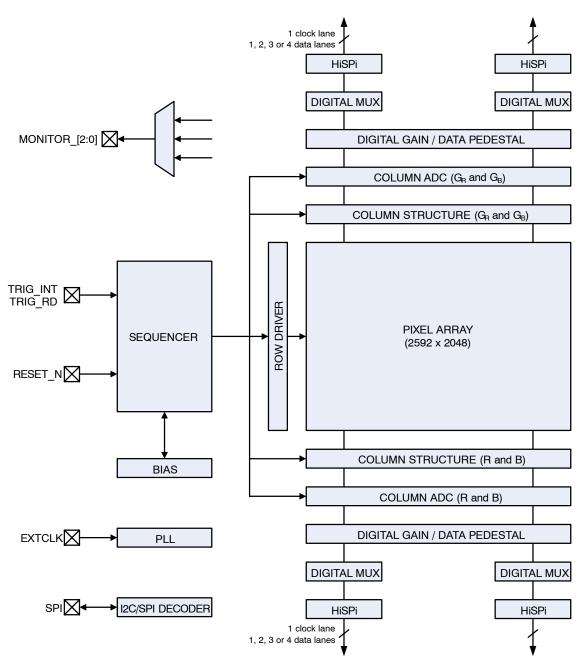


Figure 1. Functional Block Diagram (XGS 5000)

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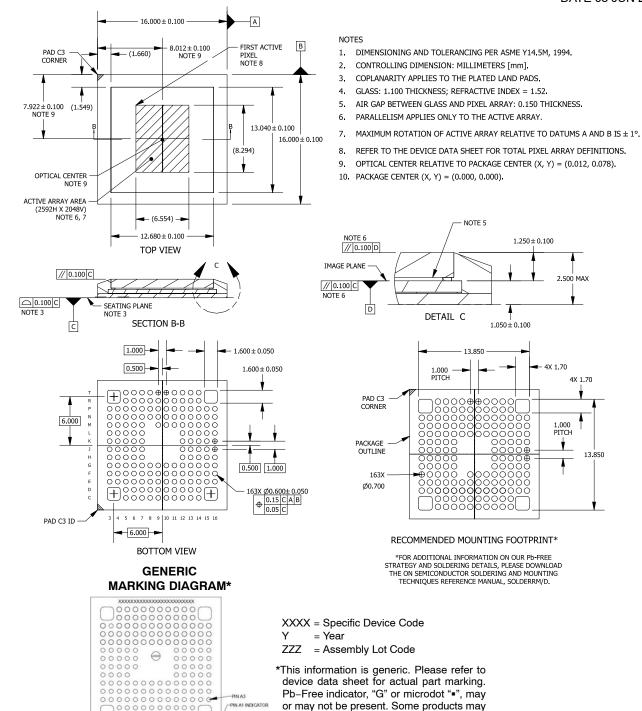




ILGA163 16x16

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